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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Darin A. Chan, et al. : Confirmation No.: 2464
Serial No.: 10/791,094 : Art Unit: 2826
Filed: 3/1/2004 : Examiner: Kevin V. Quinto
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RESPONSE /AMENDMENT AFTER FINAL REJECTION

UNDER 37 C.F.R. §1.116

Sir:

The following Amendment and Remarks are submitted under 37 C.F.R. §1.116 in response to the Final Office Action mailed August 10, 2005, following the amendment format set forth under 37 CFR §1.121. After this introductory section, there are Amendments to the Claims and then Remarks, each starting on a separate page.

Amendments to the Claims consist of cancellation without prejudice of claims 1, 3-11, and 13-15 which are incorporated in a complete listing of the claims.